# "Divided Function" Options for the KAGRA Cryogenic Suspension

Version 2, 9/13/12 – with revisions made after the talk

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Disclaimer: the KAGRA collaboration has not yet reviewed these conceptual design options.

### Requirements

## **Proposed Solutions**

- Heat removal
- Suspension of load
- SEPARATE THE FUNCTIONS OF HEAT REMOVAL AND SUSPENSION
- Vibration isolation
- Low thermal noise
  - material and temp
  - 'clamping' loss
- High Q

- -> 1 thick sapphire ribbon
- -> 2 thin metal ribbons

- -> thinnest possible ribbons
- -> thinnest possible ribbons
- -> high Q at low temp
- -> threaded-pin clamp
- -> thin-film metal bonding

## Heat Link – sapphire ribbon

Single ribbon attached to top-front mirror surface, so it's vertical motion controls pitch.

This link does NOT carry any load, simplifying its attachment. Flat ribbon naturally allows a thin bond to flat mirror face.

## Conductivity of sapphire and metal

See viewgraphs below from Tomaru, et. al.



## Heat Transfer of Several Materials at Cryogenic Temperature

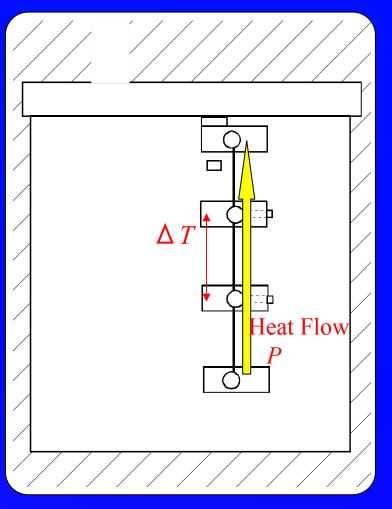
High Energy Accelerator Research Organization<sup>A</sup>
Institute for Cosmic Ray Research, University of Tokyo<sup>B</sup>

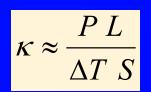
T. Tomaru<sup>A</sup>, K. Kasahara<sup>B</sup>, T. Shintomi<sup>A</sup>, T. Suzuki<sup>A</sup>, N. Sato<sup>A</sup>, T. Haruyama<sup>A</sup>, A. Yamamoto<sup>A</sup>



#### . Measurement Method of Thermal Conductivity

Longitudinal Heat Flow Method







- L: Length between thermometers
- S: Cross section of sample







#### 3. Thermal Conductivity of Sapphire Fiber

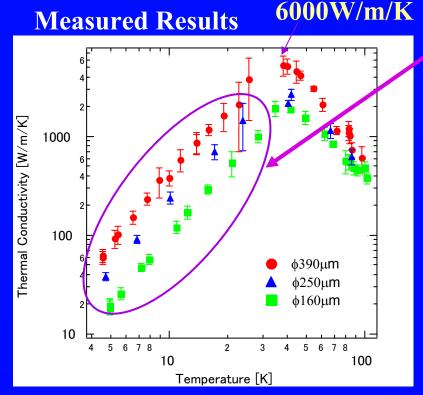
- Size Effect -



Produced by Photran LLC

Iono-crystalline sapphire FG method

160,  $\phi$  250,  $\phi$  390  $\mu$  m

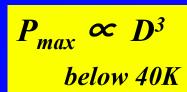


- •Estimated maximum heat transfer for the LCGT configuration 

  ⇒ 340mW
- •Estimated heat generation in the mirrors ⇒ a few W

It is important to reduce optical absorption in the mirrors
(For small pieces of sapphire, sufficient absorption level has been achieved.)

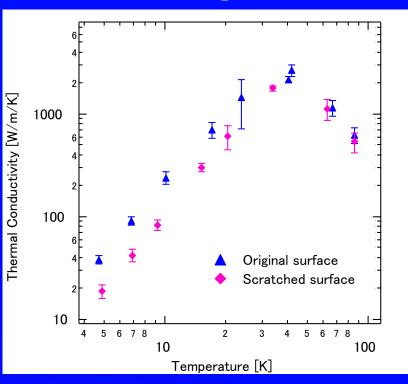
Size effect  $\kappa = \frac{1}{3} C_{v} v l$   $C_{v} \propto T^{3}$   $v \approx Const.$   $\kappa \propto C_{v} \propto T^{3}$  @ < 40K  $l \approx Const.$ 

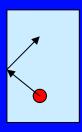




## Possibility to enhance thermal conductivity Phonon Reflection Effect -

#### $\Phi$ 250 $\mu$ m Sample





#### Original Surface



#### Scratched Surface



#8000 Diamond paste

Thermal conductivity of crystalline fiber can be enhanced at cryogenic temperature by increasing its surface quality.

[VC Rome 9/10/12]

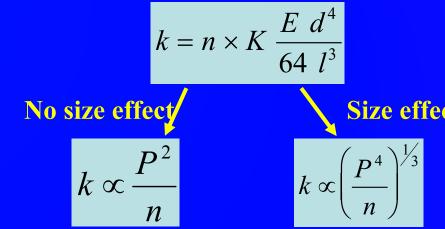
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#### . Thermal Conductivity of Pure Al and Cu

#### Requirement for the heat link:

- Large thermal conductivity
- •Small spring constant to make mechanically weak heat link



#### **Sey point**

• Whether the size effect exists or not in metals.



#### Sample

•Al: 99.999% purity

 $\phi$  2mm,  $\phi$  1.5mm,  $\phi$  1mm,

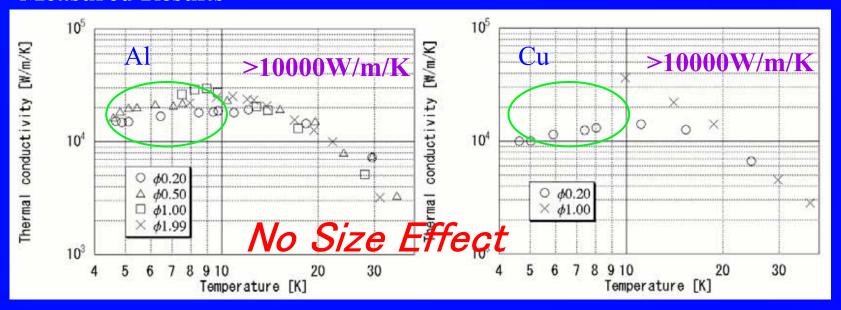
 $\phi$  0.5mm,  $\phi$  0.2mm

•Cu: 99.9999% purity

 $\phi$  1mm,  $\phi$  0.2mm



#### **Measured Results**



$$RRR = \frac{R_{300K}}{R_{4.2K}}$$

Sample	Aluminum				Copper	
	ф0.20mm	ф0.50mm	φ1.00mm	φ1.99mm	ф0.20mm	φ1.00mm
RRR	2900	4800	5500	6200	960	4100

$$\kappa^{(Al)} = \frac{1}{1.8 \times 10^{-7} \ T^2 + 1.1/RRR/T}$$

$$\kappa^{(Cu)} = \frac{1}{6.2 \times 10^{-8} \ T^{2.4} + 0.53/RRR/T}$$

It is effective to **use many thin wires** as keeping total cross section to make mechanically weak heat link,

## Calculated heat transfer

Heat transfer  $\dot{Q}$  and cross-section  ${\it A}$  are constant along heat link, but conductivity varies

SO

$$\dot{Q} = \kappa A \frac{dT}{dx}$$

becomes

$$\dot{Q} = \frac{A}{L} \int_{T_0}^{T_L} \kappa(T) dT$$

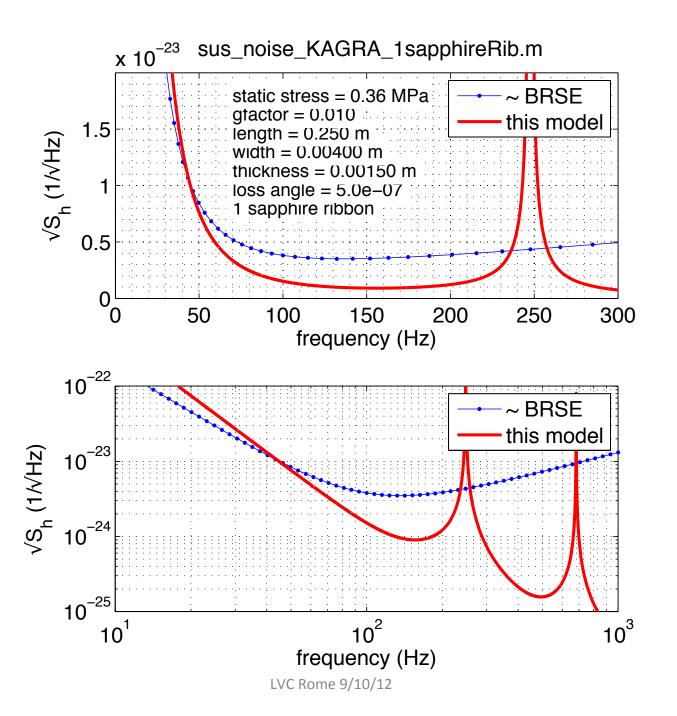
## Tomaru results, scaled by size effect

$$\dot{Q} = \left(\frac{1.5}{0.39}\right) \frac{1.5 \text{mm} \cdot 4 \text{mm}}{250 \text{mm}} \int_{10}^{20} \kappa(T) dT = 1.06 \text{ W}$$

So these dimensions, 1.5x4x250 mm, meet the heat extraction requirement.

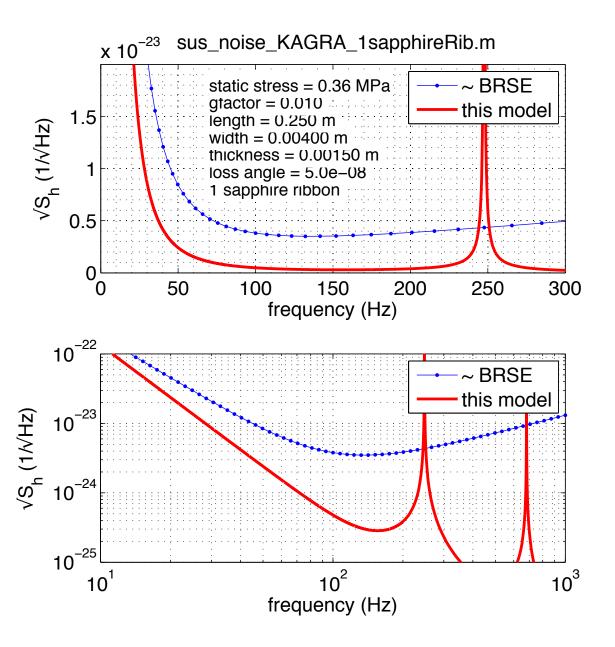
### Thermal noise from thick ribbon

- Calculate Im(Y) for flexing-beam-equation under <u>no</u> tension [Gonzalez, Saulson, Levin, et.al.), use FD theorem.
- Assume  $Q = 2 \times 10^6$  T = 20 K m = 22 kg



## result

- Using this low value of sapphire Q and high value of thickness, leads to thermal noise from the heat link to be larger than optical noise ("~BRSE") below 50 Hz
- The size of the peak at 250 Hz is partly due to the high mass of the thick and wide ribbon.
- So probably want sapphire fibers with higher Q, by a factor of 10, (see below) which other measurements indicate should be possible.



## Description of load bearing parts

- 2 metal wires support the entire weight of mirror. Use Cu:Be for high yield strength (~1 GPa).
- Wires are actually ribbons (annealed to `soft', rolled, and heat-treated to `hard' (high Q))
- Two clamp blocks connect a ribbon to the mirror.

### rationale

- Metal is more "robust" than crystals (compare the fracture toughness)
- Mechanical loss can be quite small (at cryogenic temperatures) for the right metals.
- clamping ribbons (instead of round wires) can avoid stress concentrations. (=> Lower clamping loss?)
- Thin metal films can be used to "weld" ribbons to sapphire clamp-blocks.

## Here is metal with high Q (and high strength).

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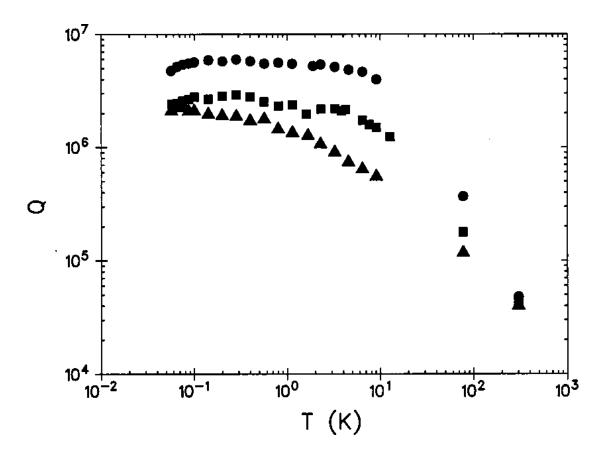
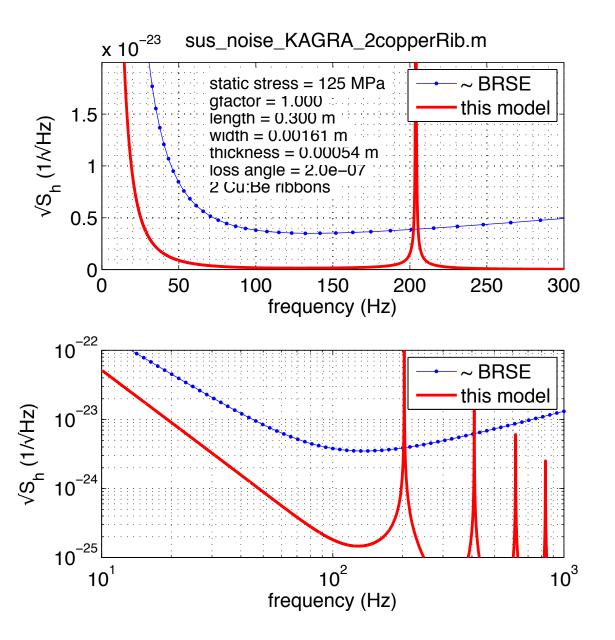
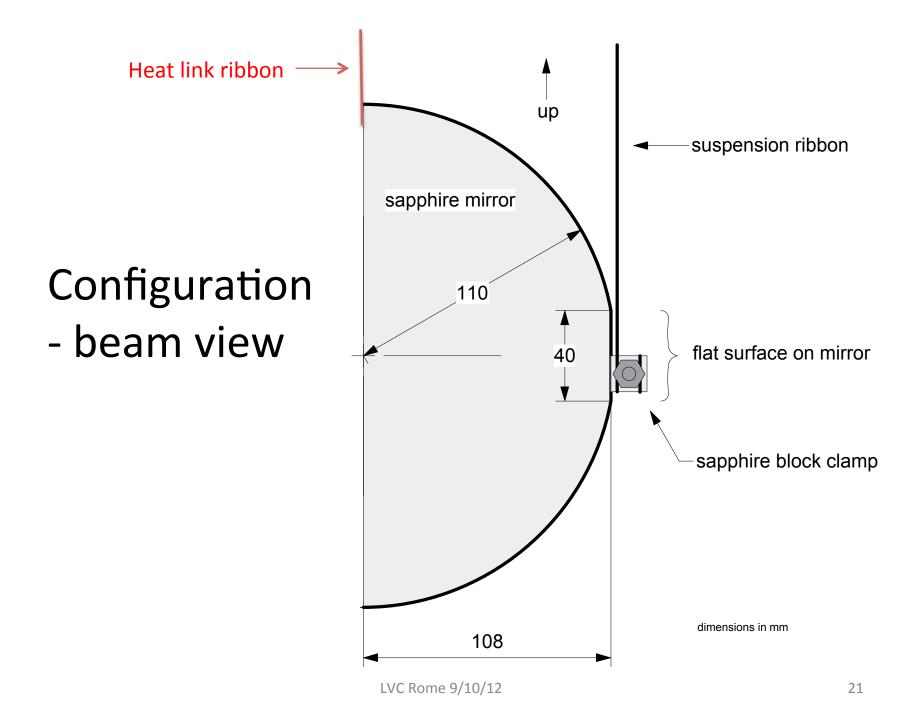


FIG. 2. Acoustic quality factor vs temperature of C17 500 Cu−Be−Co alloy, also commonly known as Alloy 10. Data shown are for as-machined material (■), heat-treated material (●), and doubly heat-treated material (▲).





## Configuration - Side View

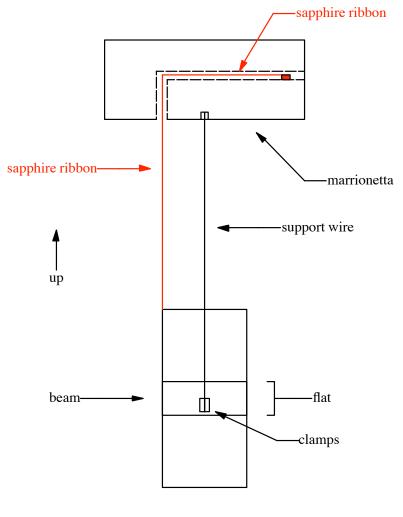
Two support metal `wires'.

One heat link ribbon (no load)

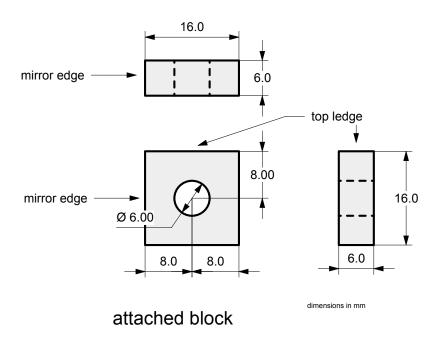
with a `blade spring' to

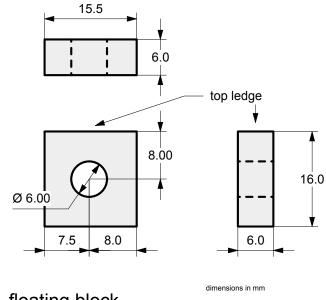
soften the connection to

the stage above (the "marrionetta")

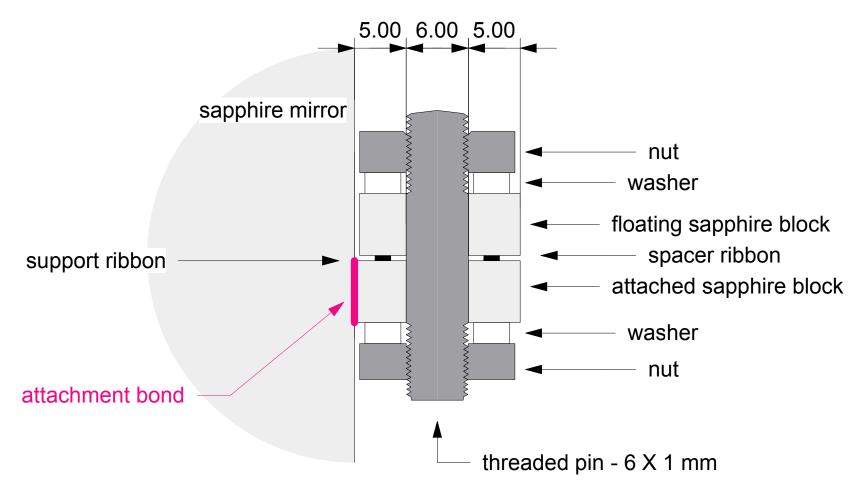


## 2 clamp blocks





floating block



Cross-section in horizontal plane

dimensions in mm

## single-threaded-pin clamp block

## **Further Options**

- sapphire ribbon fabrication:
  - EGF rod or ribbon, then lapped and polished (I have found commercial fabricators in US of such ribbons)
- metal thin-film bonds for joining sapphire to sapphire
  - thin metal film deposition is an industry.
  - Compress and heat two coated sapphire pieces to form molecular bonds.

- A speed-up for cooling in a vacuum (suggested by DeSalvo, Tanner)
  - Grind and polish a flat surface on bottom of mirror, coat with "black",
  - make a movable cold-black surface for low-load touch
- Use (Cu:Be) blade springs to make vertical springs
  - Special consideration : Colder → stiffer → Lift
  - Solution: Adjust height with a lighter load, tuned for the room temperature.
- Differential thermal contraction
  - Use to increase or adjust clamping force at low temp